

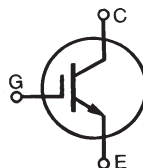
High Voltage IGBTs

IXGT4N250C IXGH4N250C

$$V_{CES} = 2500V$$

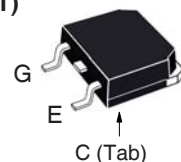
$$I_{C110} = 4A$$

$$V_{CE(sat)} \leq 6.0V$$

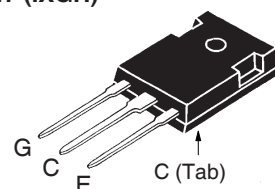


Symbol	Test Conditions	Maximum Ratings	
V_{CES}	$T_C = 25^\circ C$ to $150^\circ C$	2500	V
V_{CGR}	$T_J = 25^\circ C$ to $150^\circ C$, $R_{GE} = 1M\Omega$	2500	V
V_{GES}	Continuous	± 20	V
V_{GEM}	Transient	± 30	V
I_{C25}	$T_C = 25^\circ C$	13	A
I_{C110}	$T_C = 110^\circ C$	4	A
I_{CM}	$T_C = 25^\circ C$, 1ms	46	A
SSOA (RBSOA)	$V_{GE} = 15V$, $T_{VJ} = 125^\circ C$, $R_G = 20\Omega$ Clamped Inductive Load	$I_{CM} = 8$ $V_{CES} \leq 2000$	A V
P_C	$T_C = 25^\circ C$	150	W
T_J		-55 ... +150	$^\circ C$
T_{JM}		150	$^\circ C$
T_{stg}		-55 ... +150	$^\circ C$
T_L	1.6mm (0.062 in.) from Case for 10s	300	$^\circ C$
T_{SOLD}	Plastic Body for 10 seconds	260	$^\circ C$
M_d	Mounting Torque (TO-247)	1.13/10	Nm/lb.in.
Weight	TO-268	4	g
	TO-247	6	g

TO-268 (IXGT)



TO-247 (IXGH)



G = Gate C = Collector
E = Emitter Tab = Collector

Features

- Fast Turn off IGBTs
- International Standard Packages

Advantages

- High Power Density
- Low Gate Drive Requirement

Applications

- Buck Converters
- Switch-Mode and Resonant-Mode Power Supplies
- Uninterruptible Power Supplies

Symbol	Test Conditions	Characteristic Values		
		Min.	Typ.	Max.
BV_{CES}	$I_C = 250\mu A$, $V_{GE} = 0V$	2500		V
$V_{GE(th)}$	$I_C = 250\mu A$, $V_{CE} = V_{GE}$	3.0		5.0 V
I_{CES}	$V_{CE} = 0.8 \cdot V_{CES}$, $V_{GE} = 0V$ $T_J = 125^\circ C$			25 μA 1 mA
I_{GES}	$V_{CE} = 0V$, $V_{GE} = \pm 20V$			± 100 nA
$V_{CE(sat)}$	$I_C = 4A$, $V_{GE} = 15V$, Note 1 $T_J = 125^\circ C$		4.6 4.5	6.0 V V

Symbol Test Conditions

($T_J = 25^\circ\text{C}$ Unless Otherwise Specified)

Characteristic Values

		Min.	Typ.	Max.	
g_{fs}	$I_C = 4A, V_{CE} = 10V, \text{Note 1}$	4.0	6.0		S
C_{ies}	$V_{CE} = 25V, V_{GE} = 0V, f = 1\text{MHz}$		1150		pF
C_{oes}			52		pF
C_{res}			19		pF
$Q_{g(on)}$	$I_C = 4A, V_{GE} = 15V, V_{CE} = 1000V$		57		nC
Q_{ge}			8		nC
Q_{gc}			21		nC
$t_{d(off)}$	Inductive Load, $T_J = 25^\circ\text{C}$ $I_C = 4A, V_{GE} = 15V$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 20\Omega$ Note 2		350		ns
t_{fi}			29		ns
$E_{(off)}$			0.36		mJ
$t_{d(off)}$	Inductive Load, $T_J = 125^\circ\text{C}$ $I_C = 4A, V_{GE} = 15V$ $V_{CE} = 0.5 \cdot V_{CES}, R_G = 20\Omega$ Note 2		385		ns
t_{fi}			86		ns
$E_{(off)}$			0.80		mJ
R_{thJC}				0.82	$^\circ\text{C/W}$
R_{thCS}	TO-247		0.21		$^\circ\text{C/W}$

Notes:

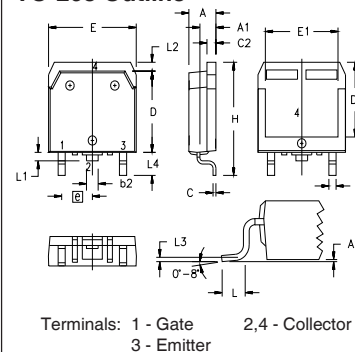
1. Pulse test, $t \leq 300\mu\text{s}$, duty cycle, $d \leq 2\%$.
2. Switching times & energy losses may increase for higher $V_{CE}(\text{Clamp})$, T_J or R_G .

Additional provisions for lead to lead voltage isolation are required at $V_{CE} > 1200V$.

ADVANCE TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

TO-268 Outline



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.193	.201	4.90	5.10
A1	.106	.114	2.70	2.90
A2	.001	.010	0.02	0.25
b	.045	.057	1.15	1.45
b2	.075	.083	1.90	2.10
C	.016	.026	0.40	0.65
C2	.057	.063	1.45	1.60
D	.543	.551	13.80	14.00
D1	.488	.500	12.40	12.70
E	.624	.632	15.85	16.05
E1	.524	.535	13.30	13.60
e	.215 BSC		5.45 BSC	
H	.736	.752	18.70	19.10
L	.094	.106	2.40	2.70
L1	.047	.055	1.20	1.40
L2	.039	.045	1.00	1.15
L3	.010 BSC		0.25 BSC	
L4	.150	.161	3.80	4.10

TO-247 Outline

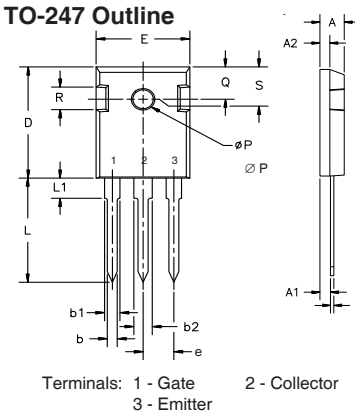


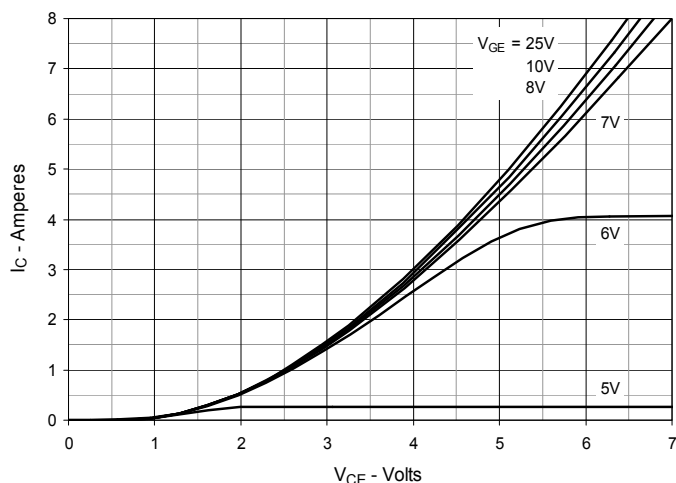
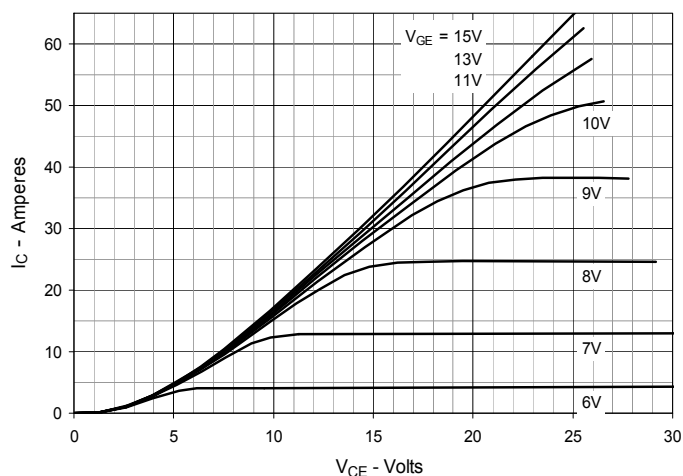
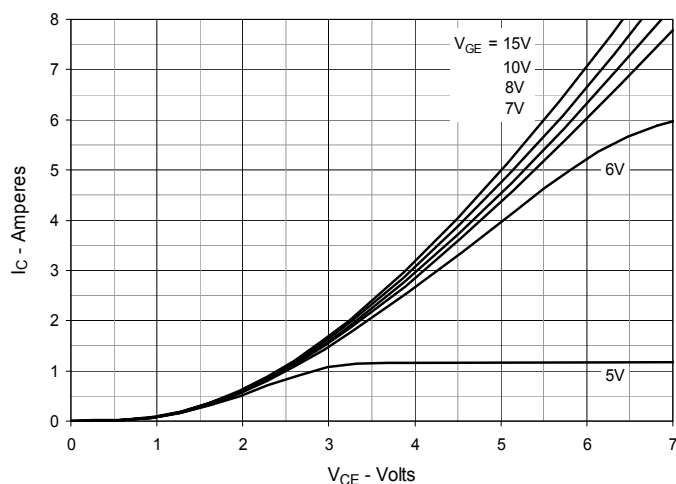
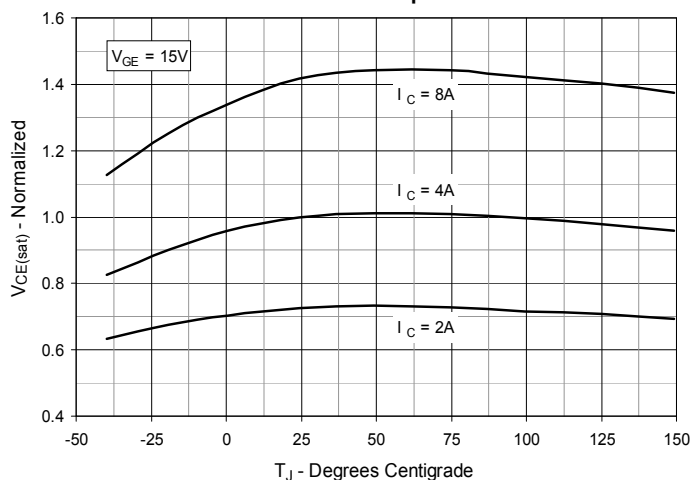
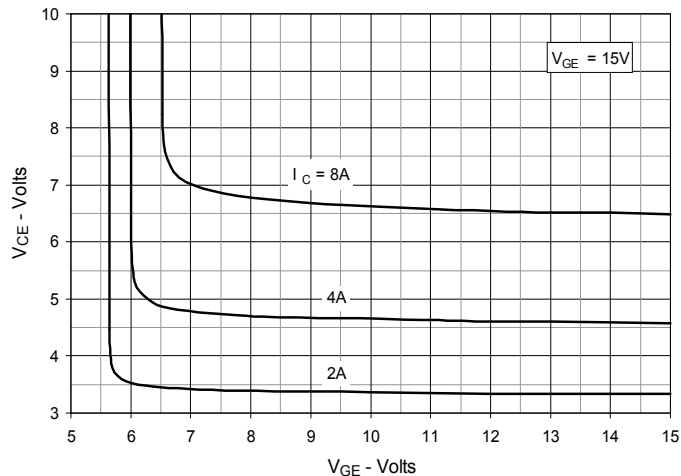
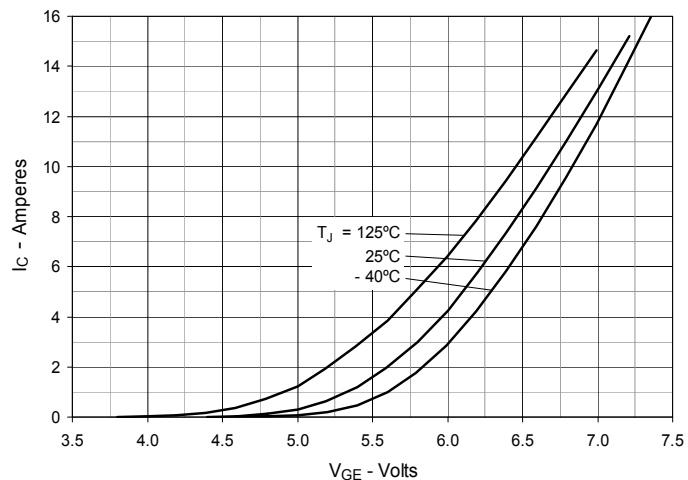
Fig. 1. Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 2. Extended Output Characteristics @ $T_J = 25^\circ\text{C}$

Fig. 3. Output Characteristics @ $T_J = 125^\circ\text{C}$

Fig. 4. Dependence of $V_{CE(sat)}$ on Junction Temperature

Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

Fig. 6. Input Admittance


Fig. 7. Transconductance

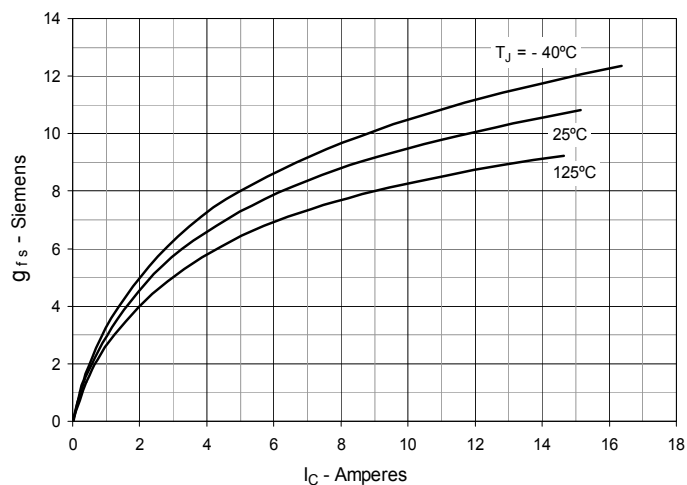


Fig. 8. Gate Charge

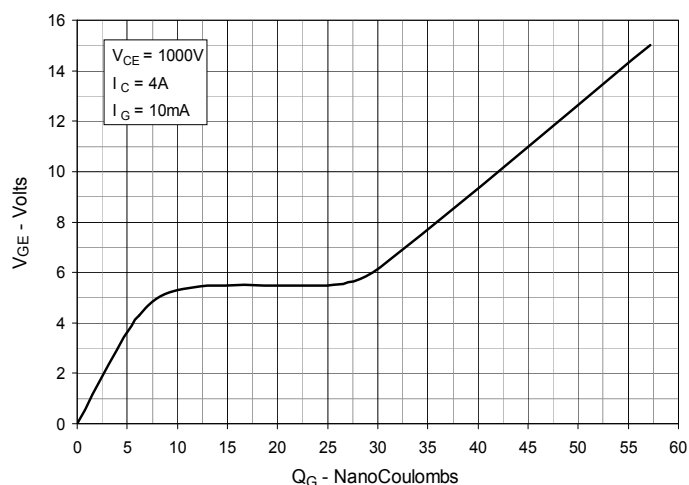


Fig. 9. Reverse-Bias Safe Operating Area

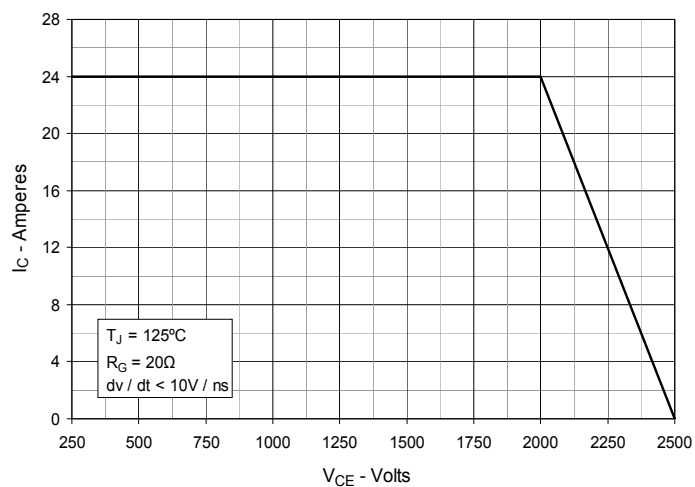


Fig. 10. Capacitance

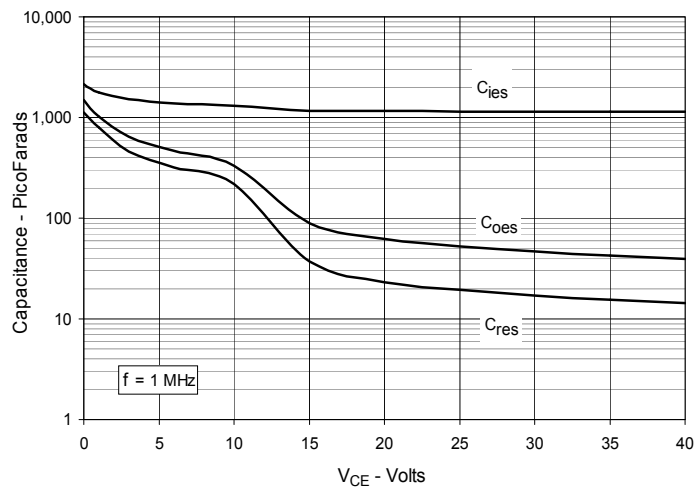
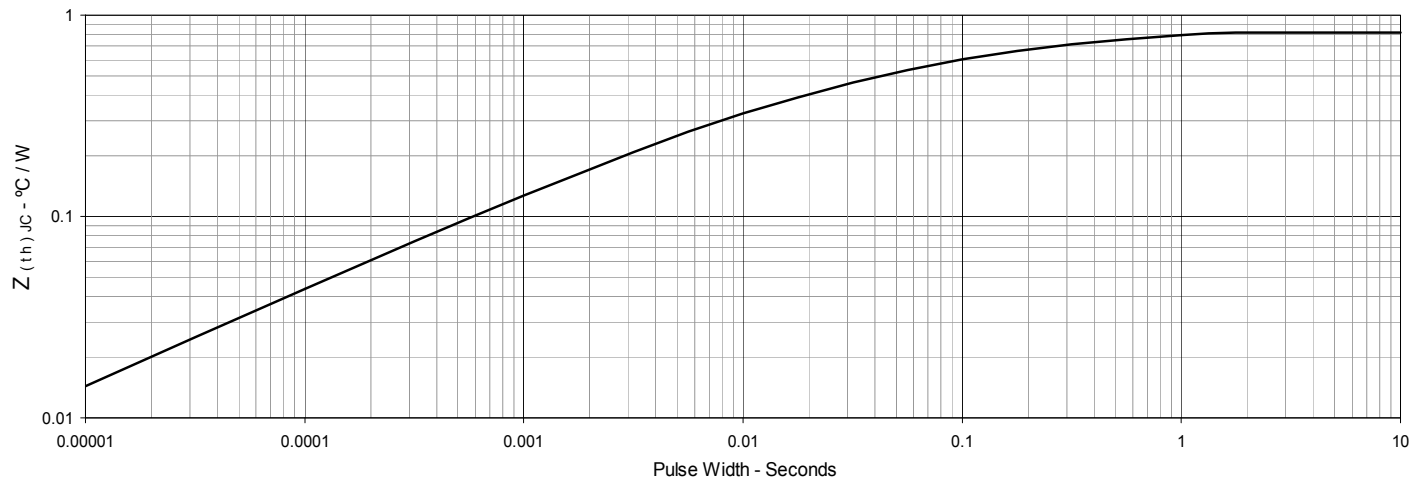


Fig. 11. Maximum Transient Thermal Impedance



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